Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type ( $L^2$ - $\pi$ -MOSV)

# 2SJ512

# Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance : RDS (ON) = 1.0  $\Omega$  (typ.)

• High forward transfer admittance :  $|Y_{fs}| = 3.7 \text{ S (typ.)}$ 

• Low leakage current : IDSS =  $-100 \mu A (max) (VDS = -250 V)$ 

• Enhancement-mode :  $V_{th} = -1.5 \sim -3.5 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA})$ 

#### Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	-250	V	
Drain-gate voltage (Ro	<sub>SS</sub> = 20 kΩ)	$V_{DGR}$	-250	V	
Gate-source voltage		$V_{GSS}$	±20	V	
Drain current	DC (Note 1)	I <sub>D</sub>	-5	Α	
	Pulse (Note 1)	I <sub>DP</sub>	-20	Α	
Drain power dissipation	n (Tc = 25°C)	$P_{D}$	30	W	
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	155	mJ	
Avalanche current		I <sub>AR</sub>	-5	Α	
Repetitive avalenche energy (Note 3)		E <sub>AR</sub>	3.0	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

SC-67

2-10R1B

Weight: 1.9 g (typ.)

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1. GATE 2. DRAIN 3. SOURCE

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	4.16	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

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Note 2:  $V_{DD}$  = -50 V,  $T_{ch}$  = 25°C (initial), L = 10.5 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = -5 A

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.

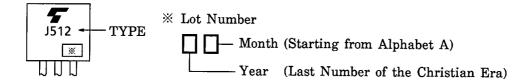
## **Electrical Characteristics (Ta = 25°C)**

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = -250 V, V <sub>GS</sub> = 0 V	_	_	-100	μΑ
Drain-source br voltage	eakdown	V <sub>(BR)DSS</sub>	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-250	1	ı	V
Gate threshold v	oltage	$V_{th}$	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-1.5	_	-3.5	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	$V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	_	1.0	1.25	Ω
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	1.8	3.7	-	S
Input capacitano	e	C <sub>iss</sub>			800	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		80	_	
Output capacitance		Coss			250	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS}^{OV}$ $I_{D}=-2.5A$ $V_{OUT}$ $R_{L}=40\Omega$ $V_{DD}=-100V$	_	16	_	- ns
	Turn-on time	t <sub>on</sub>		_	35	_	
	Fall time	t <sub>f</sub>		_	9	_	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\mathbf{W}} = 10 \mu \text{s}$	_	70		
Total gate charge (Gate-source plus gate-drain)		Qg	$V_{DD} \approx -200 \text{ V}, V_{GS} = -10 \text{ V},$ $I_D = -5 \text{ A}$	_	22	_	nC
Gate-source charge		$Q_{gs}$		_	14	_	
Gate-drain ("miller") charge		$Q_{gd}$			8	_	

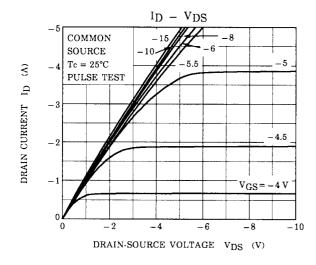
## Source-Drain Ratings and Characteristics (Ta = 25°C)

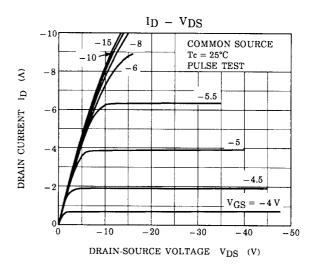
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	1	_	-5	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	-20	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = -5 A, V <sub>GS</sub> = 0 V	_	_	2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = -5 A, V <sub>GS</sub> = 0 V dI <sub>DR</sub> / dt = 100 A / μs		205	_	ns
Reverse recovery charge	Q <sub>rr</sub>			2.1	_	μC

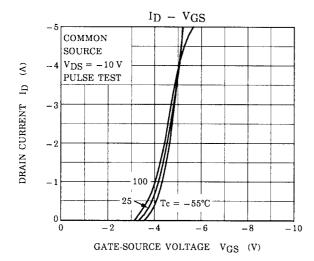
### Marking

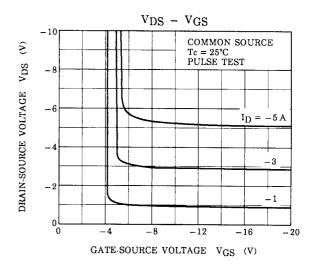


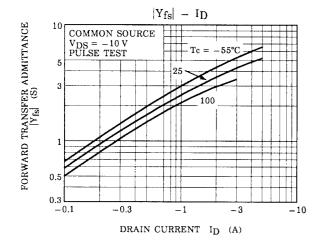
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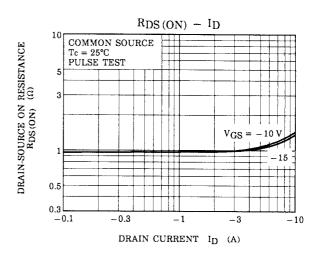




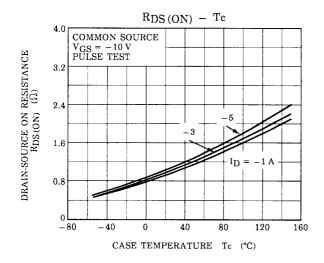


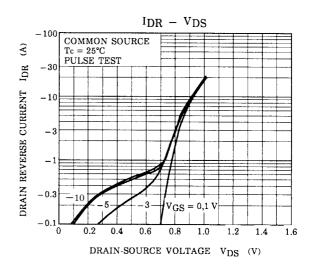


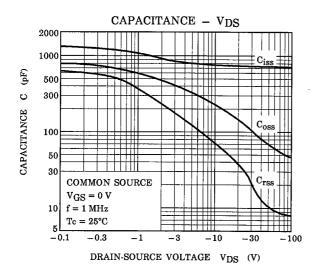


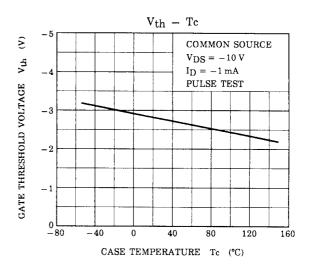


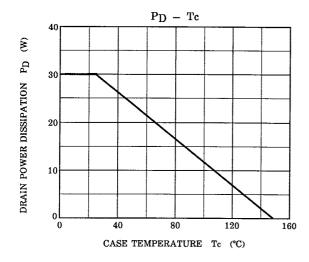
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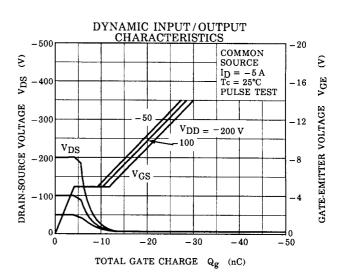




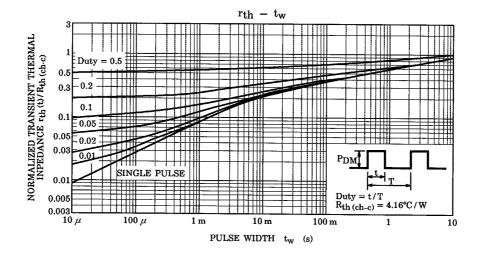


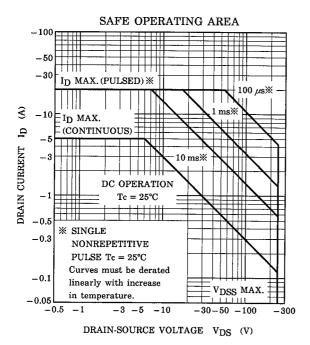


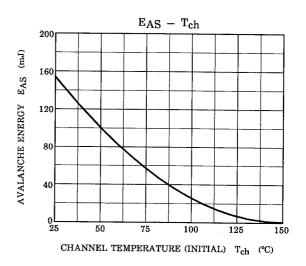


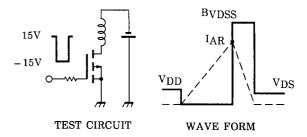


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$$\begin{array}{ll} R_G = 25\Omega \\ V_{DD} = -50V, \ L = 10.5mH \end{array} \quad E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot (\frac{B_{VDSS}}{B_{VDSS} - V_{DD}})$$

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